

TMG80P10P

P-Channel Enhancement Mosfet

<p>General Description</p> <ul style="list-style-type: none"> • Low $R_{DS(ON)}$ • RoHS and Halogen-Free Compliant <p>Applications</p> <ul style="list-style-type: none"> • Load switch • PWM 	<p>General Features</p> <p>$V_{DS} = -100\text{ V}$ $I_D = -80\text{ A}$ $R_{DS(ON)} = 22\text{ m}\Omega(\text{typ.}) @ V_{GS} = -10\text{ V}$</p> <p>100% UIS Tested 100% R_g Tested</p>
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P:TO-220AB

Marking: G80P10

G D S

Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Ratings	Units
V_{DS}	Drain-Source Voltage	-100	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Continuous Drain Current	-80	A
	Continuous Drain Current- $T_c=100^\circ\text{C}$	-41	
I_{DM}	Pulsed Drain Current	-260	
P_D	Power Dissipation	250	W
E_{AS}	Single pulse avalanche energy	---	mJ
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55-+175	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.5	$^\circ\text{C}/\text{W}$

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Electrical Characteristics: ($T_C=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-100	---	---	V
$\Delta BV_{DSS}/\Delta T_J$	BV_{DSS} Temperature Coefficient	Reference to 25°C , $I_D=-1mA$	---	---	---	$V/^{\circ}\text{C}$
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=-10V, I_D=-15A$	---	22	25	m Ω
		$V_{GS}=-4.5V, I_D=-3A$	---	---	---	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	-1	-2	-3	V
$\Delta V_{GS(th)}$	$V_{GS(th)}$ Temperature Coefficient		---	---	---	mV/ $^{\circ}\text{C}$
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=-100V, V_{GS}=0V, T_J=25^{\circ}\text{C}$	---	---	1	μA
		$V_{DS}=-100V, V_{GS}=0V, T_J=100^{\circ}\text{C}$	---	---	---	
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	± 100	nA
Q_g	Total Gate Charge	$V_{DS}=-30V, V_{GS}=-10V, I_D=-3A$	---	76	---	nC
Q_{gs}	Gate-Source Charge		---	13	---	
Q_{gd}	Gate-Drain Charge		---	12.4	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{GS}=-10V, V_{DD}=-50V,$ $R_L=0.75\Omega, R_{GEN}=3\Omega$ $I_D=-15A$	---	13	---	ns
T_r	Rise Time		---	51	---	
$T_{d(off)}$	Turn-Off Delay Time		---	177	---	
T_f	Fall Time		---	82	---	
C_{iss}	Input Capacitance	$V_{DS}=-50V, V_{GS}=0V, f=1MHz$	---	4200	---	pF
C_{oss}	Output Capacitance		---	536	---	
C_{rss}	Reverse Transfer Capacitance		---	52	---	

Diode Characteristics

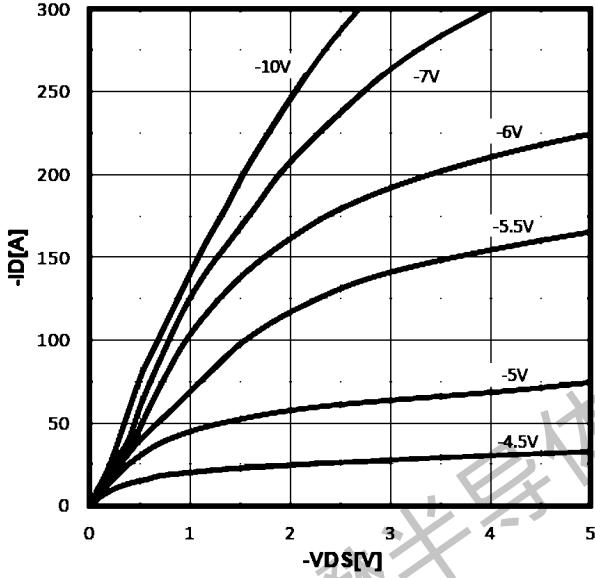
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	$V_G=V_D=0V$, Force Current	---	---	-80	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0V, I_S=-15A, T_J=25^{\circ}\text{C}$	---	---	-1.2	V
t_{rr}	Reverse Recovery Time	$I_F=-15A, di/dt=100A/\mu s,$	---	110	---	nS
Q_{rr}	Reverse Recovery Charge	$T_J=25^{\circ}\text{C}$	---	590	---	nC



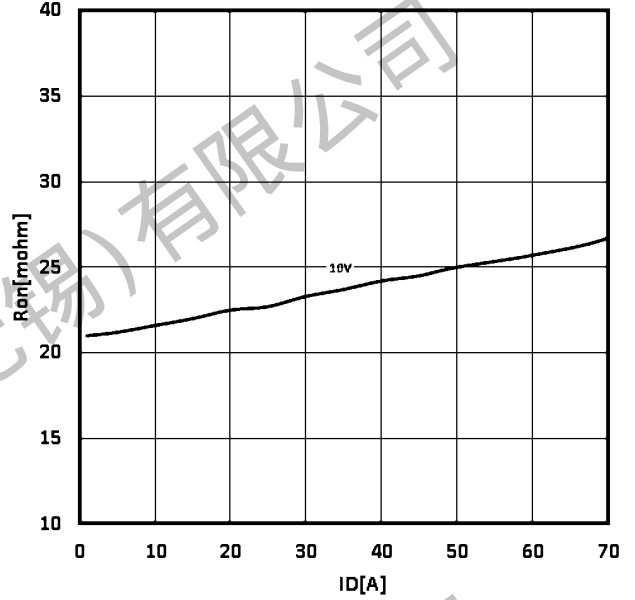
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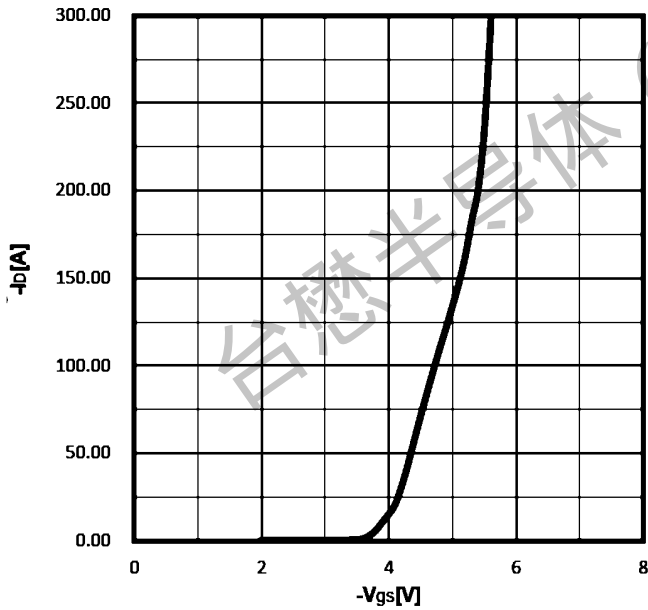
Typ. output characteristics
 $I_D=f(V_{DS})$



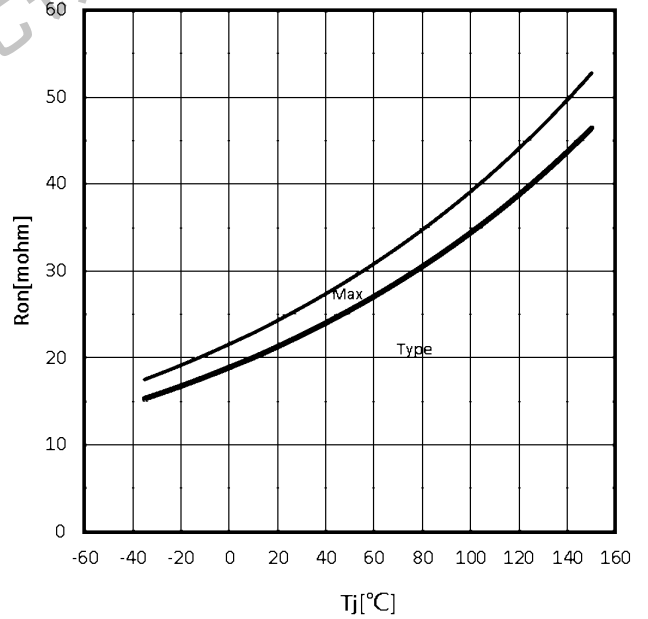
Typ. drain-source on resistance
 $R_{DS(on)}=f(I_D)$



Typ. transfer characteristics
 $I_D=f(V_{GS})$



Drain-source on-state resistance
 $R_{DS(on)}=f(T_j); I_D=-15A; V_{GS}=-10V$

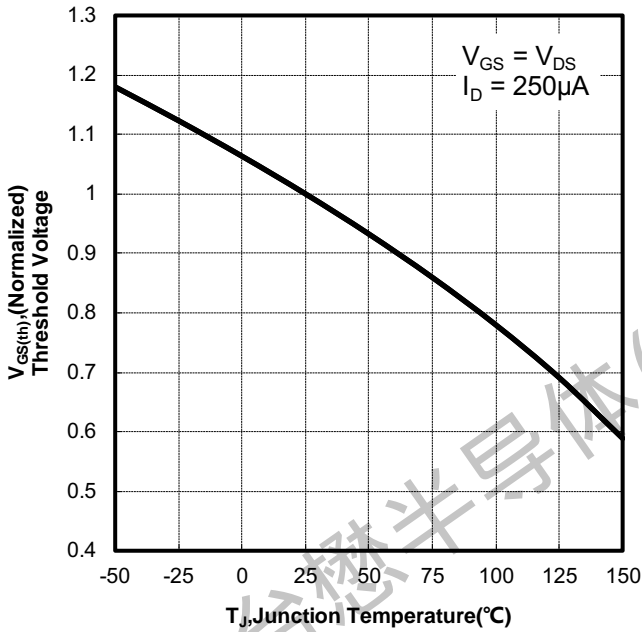




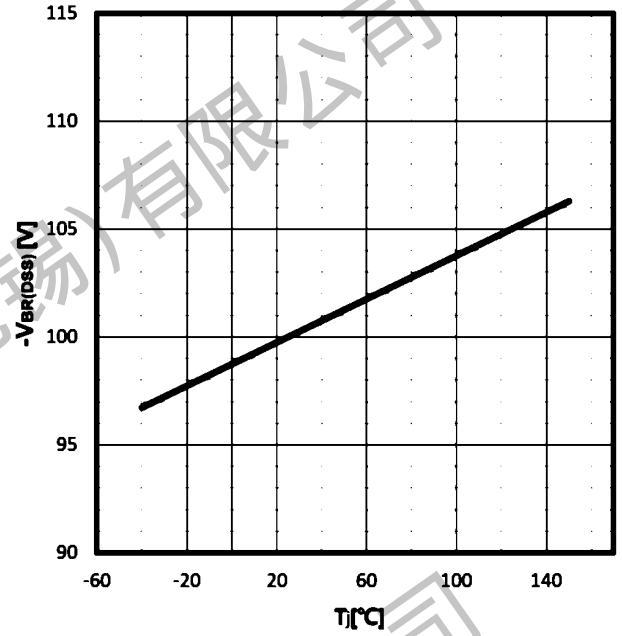
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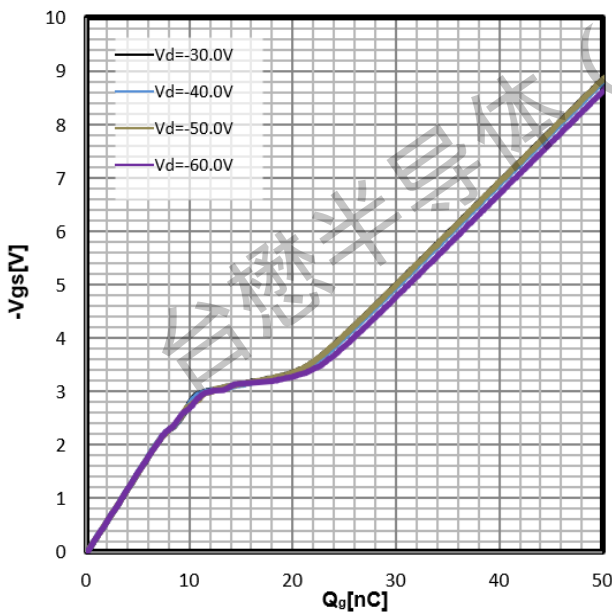
Gate Threshold Voltage
 $-V_{TH}=f(T_j); I_D=-250\mu A$



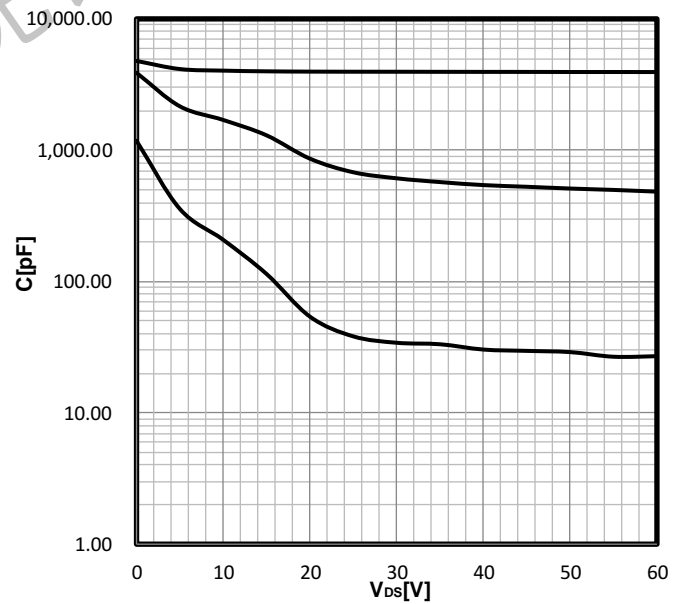
Drain-source breakdown voltage
 $V_{BR(DSS)}=f(T_j); I_D=-250\mu A$



Typ. gate charge
 $V_{GS}=f(Q_{gate}); I_D=-15A$



Typ. capacitances

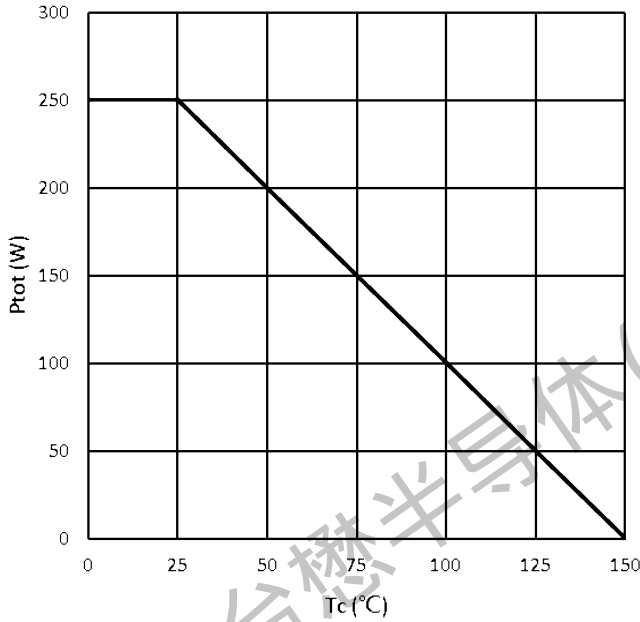




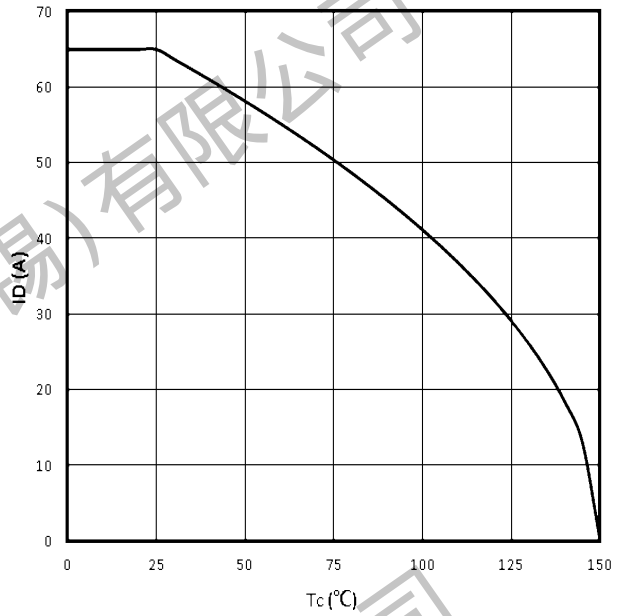
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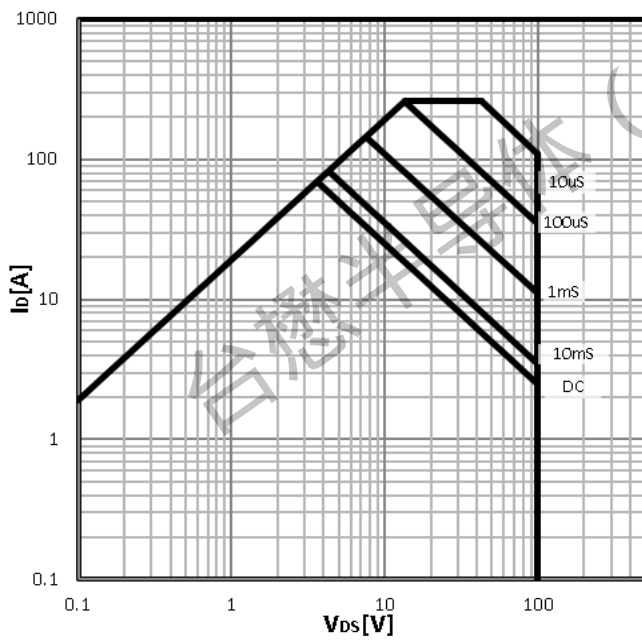
Power Dissipation
 $P_{tot}=f(T_c)$



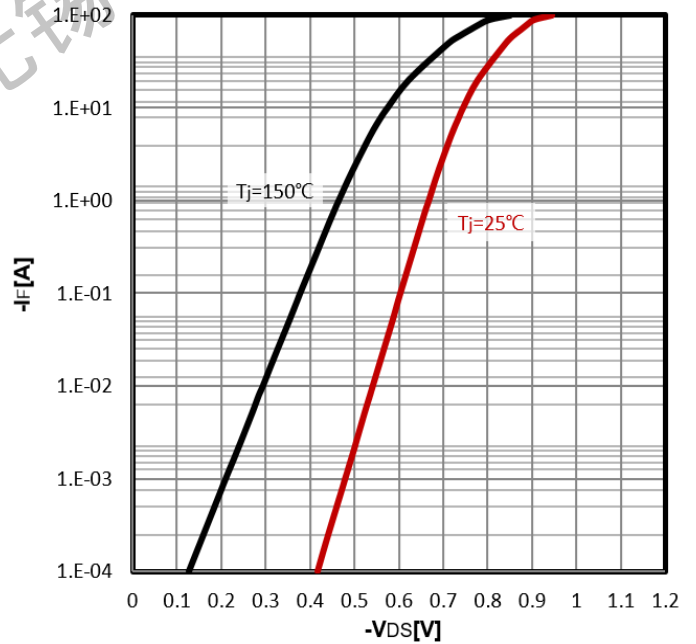
Maximum Drain Current
 $-I_D=f(T_c)$



Safe operating area
 $-I_D=f(-V_{DS})$



Body Diode Forward Voltage Variation
 $-I_F=f(-V_{DS})$



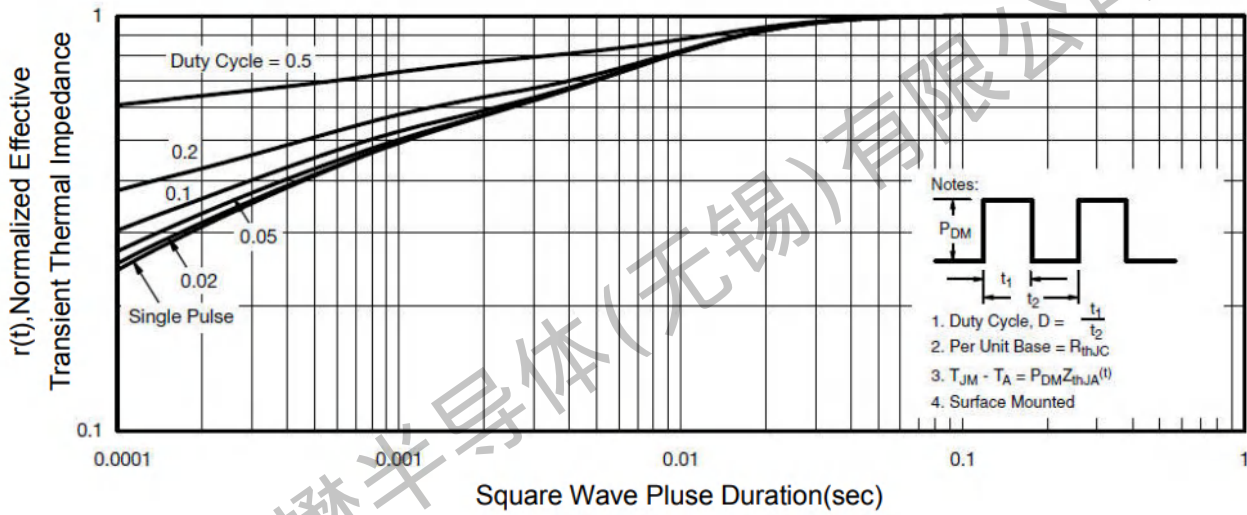


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Max. transient thermal impedance

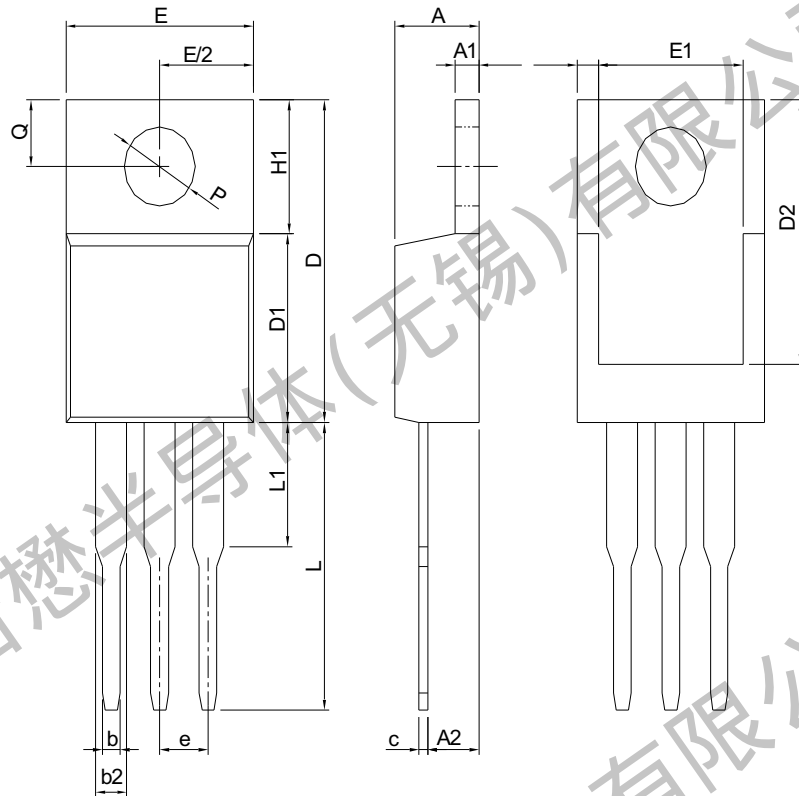
$$Z_{thJC} = f(t_p)$$



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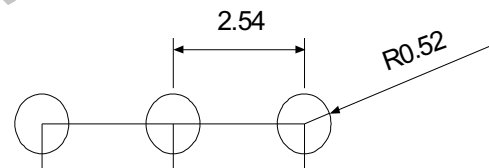
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Package Mechanical Data: TO-220AB



DIMENSIONS	TO-220			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	3.56	4.83	0.140	0.190
A1	0.51	1.40	0.020	0.055
A2	2.03	2.92	0.080	0.115
b	0.38	1.02	0.015	0.040
b2	1.14	1.78	0.045	0.070
c	0.36	0.61	0.014	0.024
D	14.22	16.51	0.560	0.650
D1	8.38	9.02	0.330	0.355
D2	12.19	13.65	0.480	0.537
E	9.65	10.67	0.380	0.420
E1	6.86	8.89	0.270	0.350
e	2.54 BSC		0.100 BSC	
H1	5.84	6.86	0.230	0.270
L	12.70	14.73	0.500	0.580
L1	-	6.35	-	0.250
P	3.53	4.09	0.139	0.161
Q	2.54	3.43	0.100	0.135

RECOMMENDED LAND PATTERN

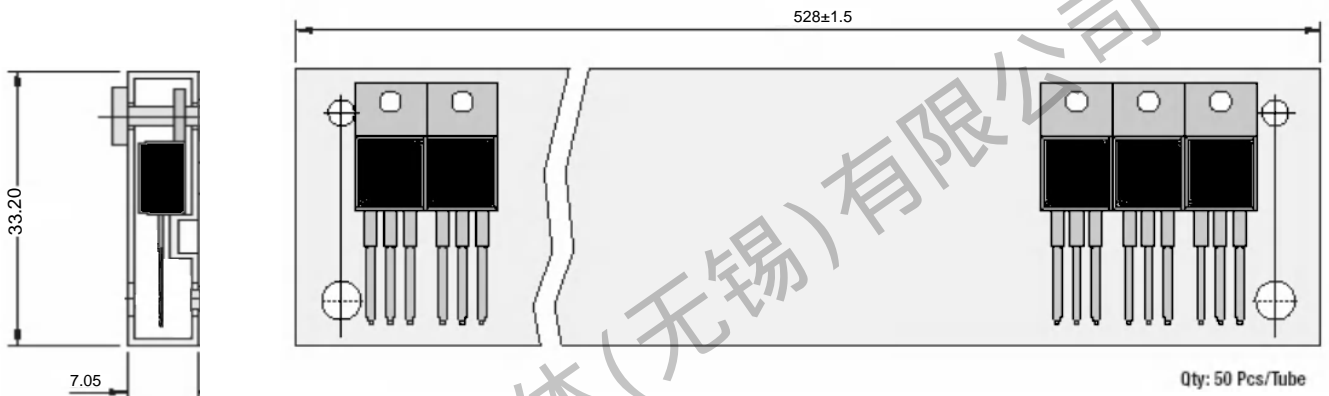


UNIT: mm

Note: Follow JEDEC TO-220 AB.

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All Dimensions are in mm

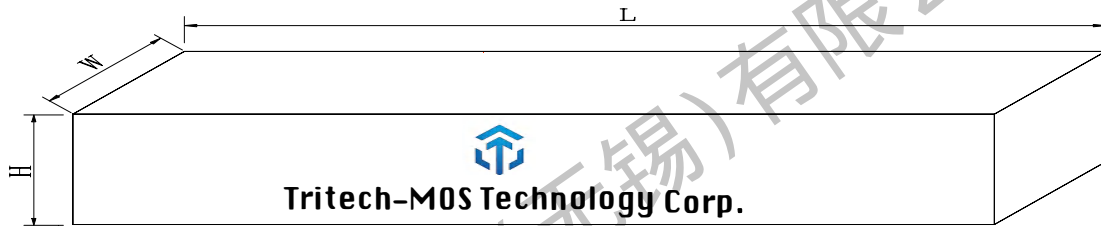
1.TO-220AB Packaging

Package	Packing Form	Quantity		
		Tube	Inner Box [kpcs]	Outbox [kpcs]
TO-220AB	Tube Tape	50	5	1

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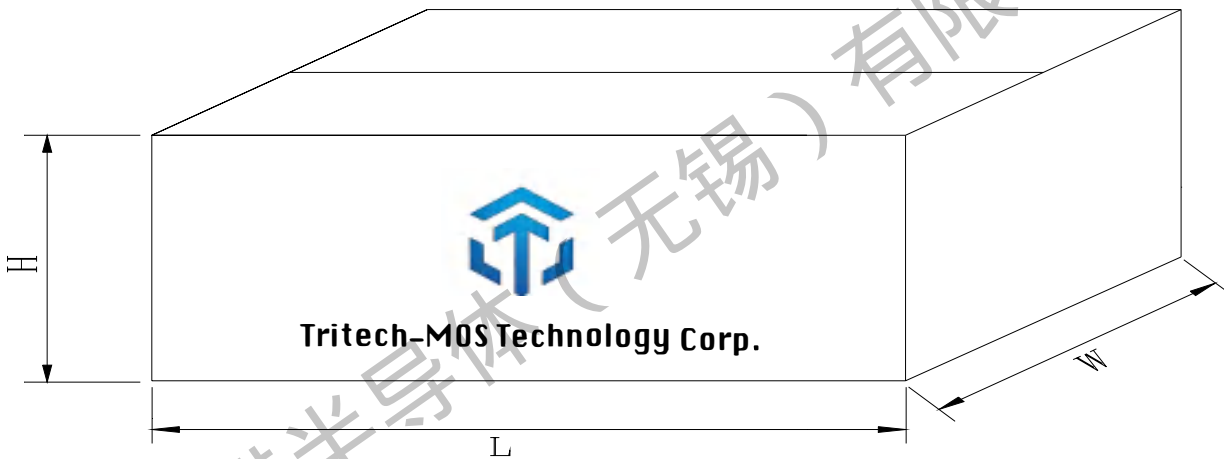
Inner Box



Dimension : 580 (L)×154(W) ×49(H) mm

Quantity : 50 ×20Ea = 1Kpcs

Outer Box



Dimension : 595(L)×285(W) ×185(H) mm

Quantity : 1K×5Ea = 5Kpcs

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Revision history:

Date	Rev	Description	Page
2023.06.30	23.06	Original	